

ABSTRACT

A lead frame (1) has a back surface (1b) having a multiple-irradiated region (1c) that is irradiated with laser light (L2) scanned in a first scan step and laser light (L3) scanned in a second scan step, a unit resin molded product (12) that is formed in a cutting step has corner regions (12t) overlapping the multiple-irradiated region (1c) of the lead frame (1), and the multiple-irradiated region (1c) prevents the laser light (L2) emitted to the back surface (1b) from reaching portions of the resin material (9) on the front surface (1a) of the lead frame (1), the portions being located at a position corresponding to the corner regions (12t).